E1WCDA12-32.768K Calick part number to visit Part Number Details page



REGULATORY COMPLIANCE (Data Sheet downloaded on Dec 2, 2017)









Click badges to download compliance docs

Regulatory Compliance standards are subject to updates by governing bodies. Click the badges to download the latest compliance docs for this part number directly from Ecliptek.



ITEM DESCRIPTION

Watch Crystal Resonator 2.1mm x 6.2mm Thru-Hole Metal Cylindrical 32.768KHz ±20ppm at 25°C 12.5pF Parallel Resonant

ELECTRICAL SPECIFICATIONS		
Nominal Frequency	32.768KHz	
Frequency Tolerance	±20ppm at 25°C	
Frequency Stability Temperature Coefficient	-0.034ppm ±0.006ppm/(Change in °C)² Maximum	
Turn over Temperature	25°C ±5°C	
Aging at 25°C	±3ppm/year Maximum	
Operating Temperature Range	-10°C to +60°C	
Load Capacitance	12.5pF Parallel Resonant	
Shunt Capacitance	2pF Maximum	
Motional Capacitance	3.0fF Typical	
Equivalent Series Resistance	35,000 Ohms Maximum	
Mode of Operation	Fundamental	
Drive Level	1μWatt Maximum	
Crystal Cut	Tuning Fork	
Storage Temperature Range	-40°C to +85°C	
Insulation Resistance	500 Megaohms Minimum (Measured at 100Vdc)	

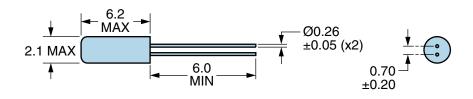
ENVIRONMENTAL & MECHANICAL SPECIFICATIONS		
Fine Leak Test	MIL-STD-883, Method 1014, Condition A	
Gross Leak Test	MIL-STD-883, Method 1014, Condition C	
Mechanical Shock	MIL-STD-202, Method 213, Condition C	
Resistance to Soldering Heat	MIL-STD-202, Method 210, Condition B	
Solderability	MIL-STD-883, Method 2003	
Vibration	MIL-STD-883, Method 2007, Condition A	

www.ecliptek.com | Specification Subject to Change Without Notice | Revision B 04/13/2015 | Page 1 of 4

E1WCDA12-32.768K Click part number to visit



MECHANICAL DIMENSIONS (all dimensions in millimeters)

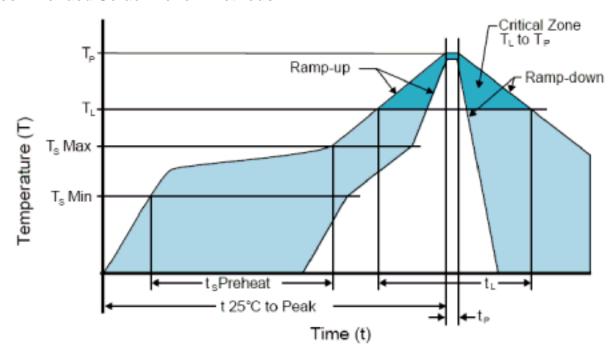


LINE	MARKING
1	XXXX XXXX=Ecliptek Manufacturing Identifier
2	XXXX XXXX=Ecliptek Manufacturing Identifier

E1WCDA12-32.768K Colick part number to visit



Recommended Solder Reflow Methods



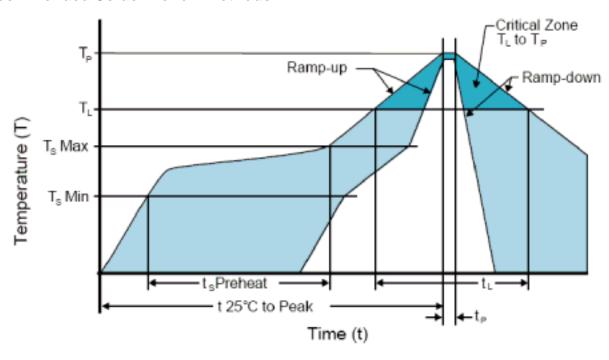
High Temperature Solder Bath (Wave Solder)

<u> </u>	,
Ts MAX to T∟ (Ramp-up Rate)	3°C/Second Maximum
Preheat	
- Temperature Minimum (Ts MIN)	150°C
- Temperature Typical (Ts TYP)	175°C
- Temperature Maximum (Ts MAX)	200°C
- Time (ts MIN)	60 - 180 Seconds
Ramp-up Rate (T∟ to T _P)	3°C/Second Maximum
Time Maintained Above:	
- Temperature (T∟)	217°C
- Time (t∟)	60 - 150 Seconds
Peak Temperature (T _P)	260°C Maximum for 10 Seconds Maximum
Target Peak Temperature (T _P Target)	250°C +0/-5°C
Time within 5°C of actual peak (tp)	20 - 40 Seconds
Ramp-down Rate	6°C/Second Maximum
Time 25°C to Peak Temperature (t)	8 Minutes Maximum
Moisture Sensitivity Level	Level 1
Additional Notes	Temperatures shown are applied to back of PCB board and device leads only.

E1WCDA12-32.768K Colick part number to visit



Recommended Solder Reflow Methods



Low Temperature Solder Bath (Wave Solder)

Ts MAX to T∟ (Ramp-up Rate)	5°C/Second Maximum
Preheat	
- Temperature Minimum (Ts MIN)	N/A
- Temperature Typical (Ts TYP)	150°C
- Temperature Maximum (Ts MAX)	N/A
- Time (ts MIN)	30 - 60 Seconds
Ramp-up Rate (T∟ to T _P)	5°C/Second Maximum
Time Maintained Above:	
- Temperature (T∟)	150°C
- Time (t∟)	200 Seconds Maximum
Peak Temperature (T _P)	245°C Maximum
Target Peak Temperature (T _P Target)	245°C Maximum 1 Time / 235°C Maximum 2 Times
Time within 5°C of actual peak (t _P)	5 Seconds Maximum 1 Time / 15 Seconds Maximum 2 Times
Ramp-down Rate	5°C/Second Maximum
Time 25°C to Peak Temperature (t)	N/A
Moisture Sensitivity Level	Level 1
Additional Notes	Temperatures shown are applied to back of PCB board and device leads only.

Low Temperature Manual Soldering

185°C Maximum for 10 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to back of PCB board and device leads only.)

High Temperature Manual Soldering

260°C Maximum for 5 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to back of PCB board and device leads only.)

www.ecliptek.com | Specification Subject to Change Without Notice | Revision B 04/13/2015 | Page 4 of 4